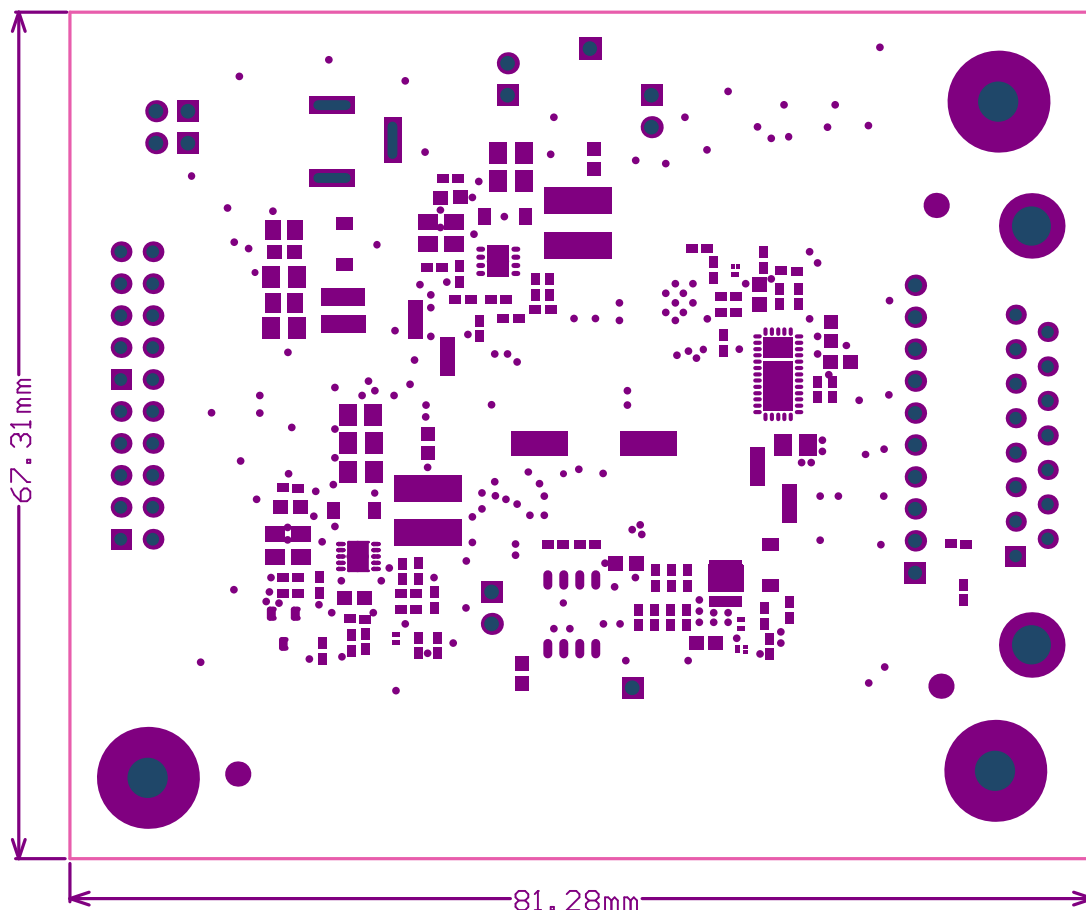
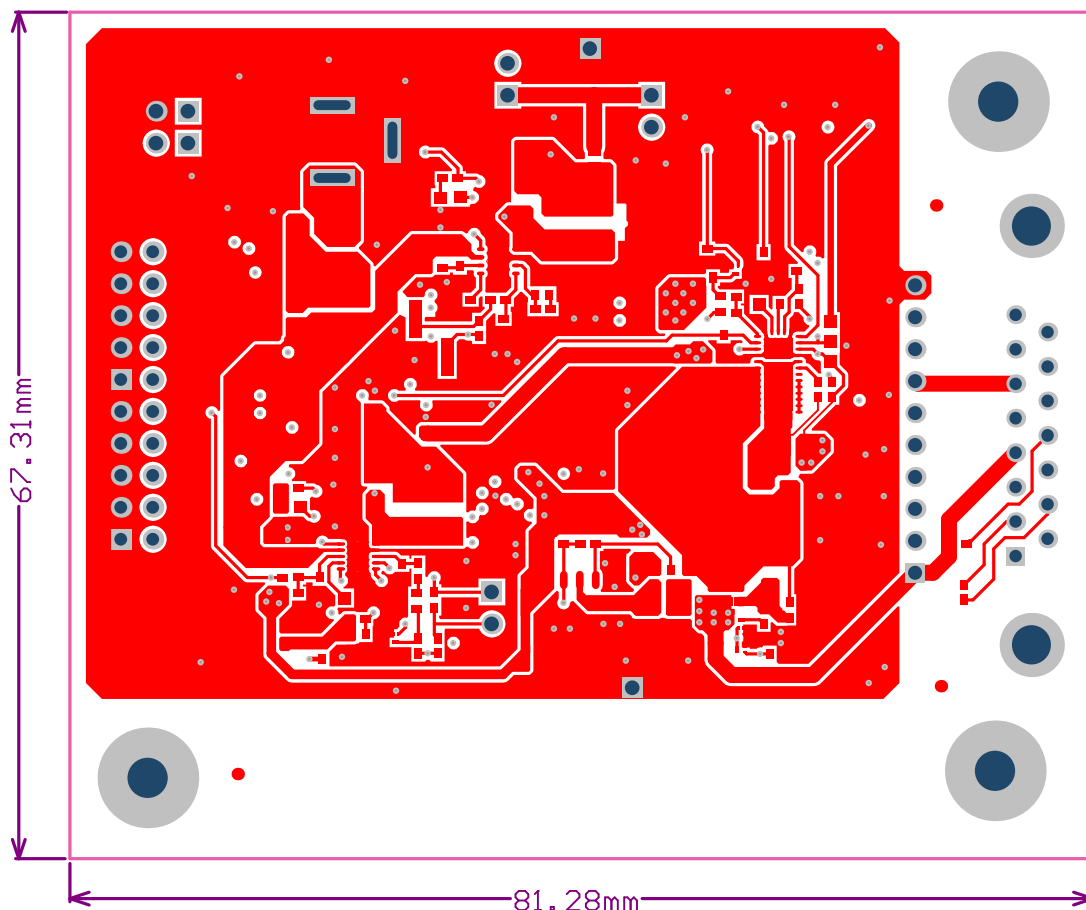


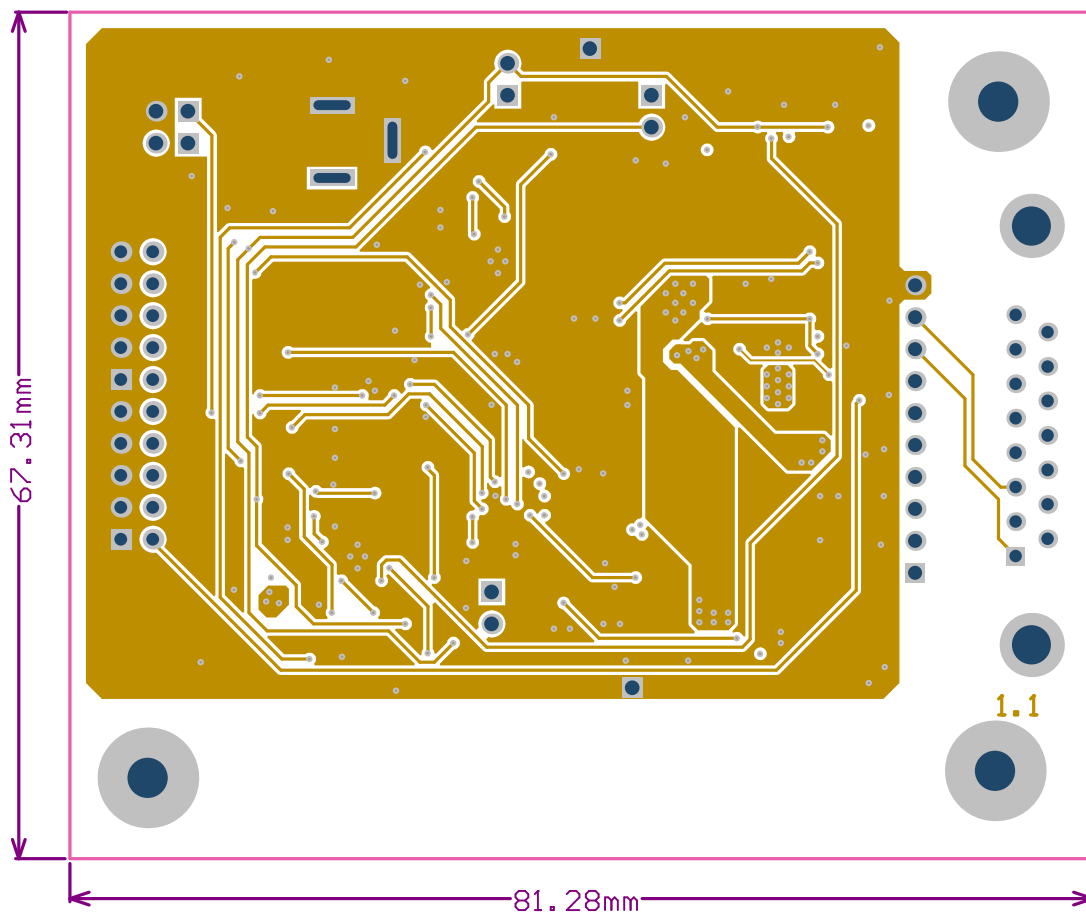
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Top Overlay	GENERATED : 9/25/2015 10:28:28 AM	TEXAS INSTRUMENTS	



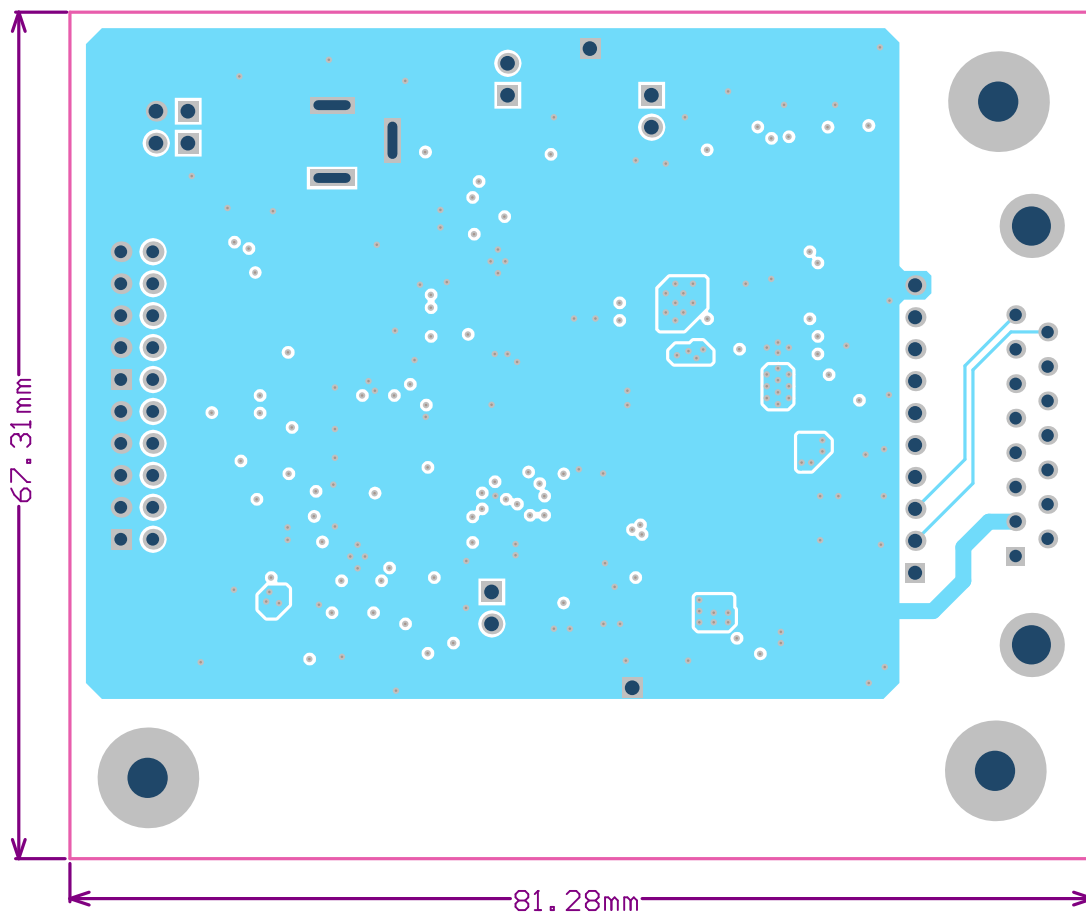
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M@pB6@r@d@Dimensions			
PLOT NAME = Top Solder Mask	GENERATED : 9/25/2015 10:28:29 AM	TEXAS INSTRUMENTS	



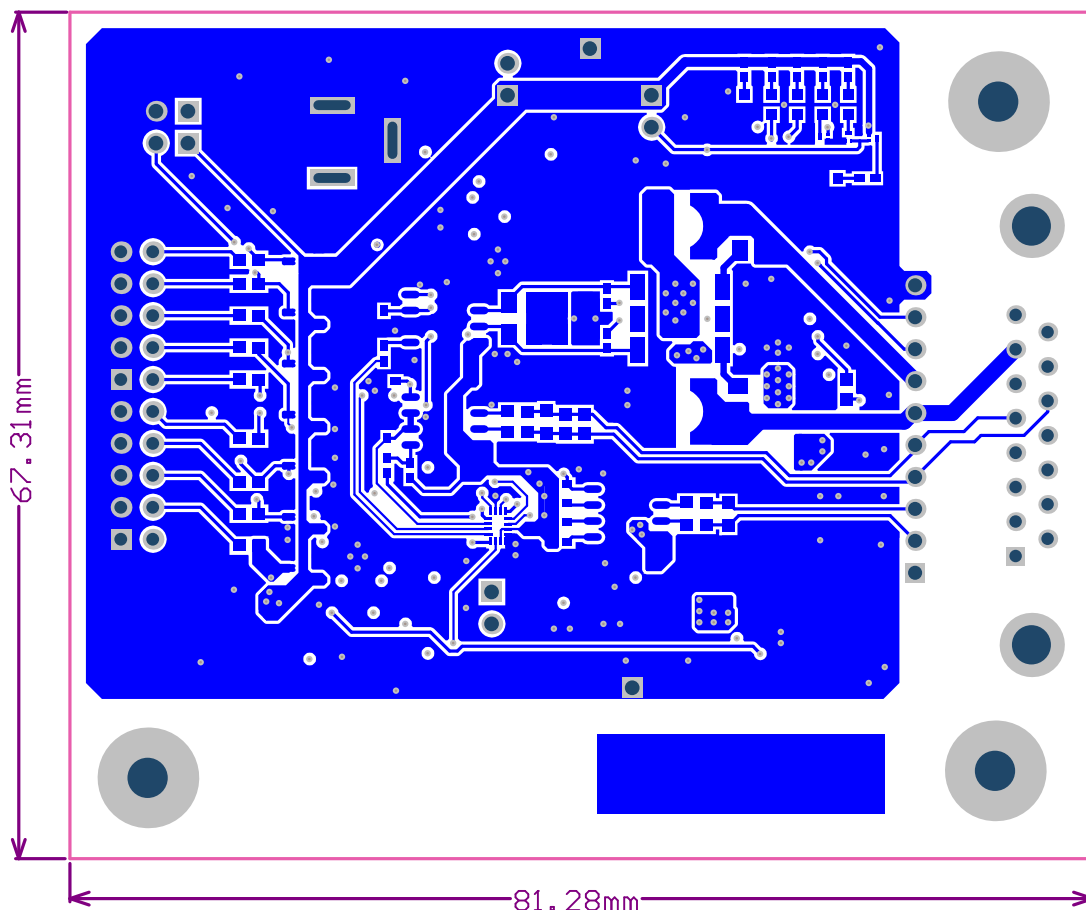
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M@pBbagdrDimensions			
PLOT NAME = Top Layer	GENERATED : 9/25/2015 10:28:30 AM	TEXAS INSTRUMENTS	



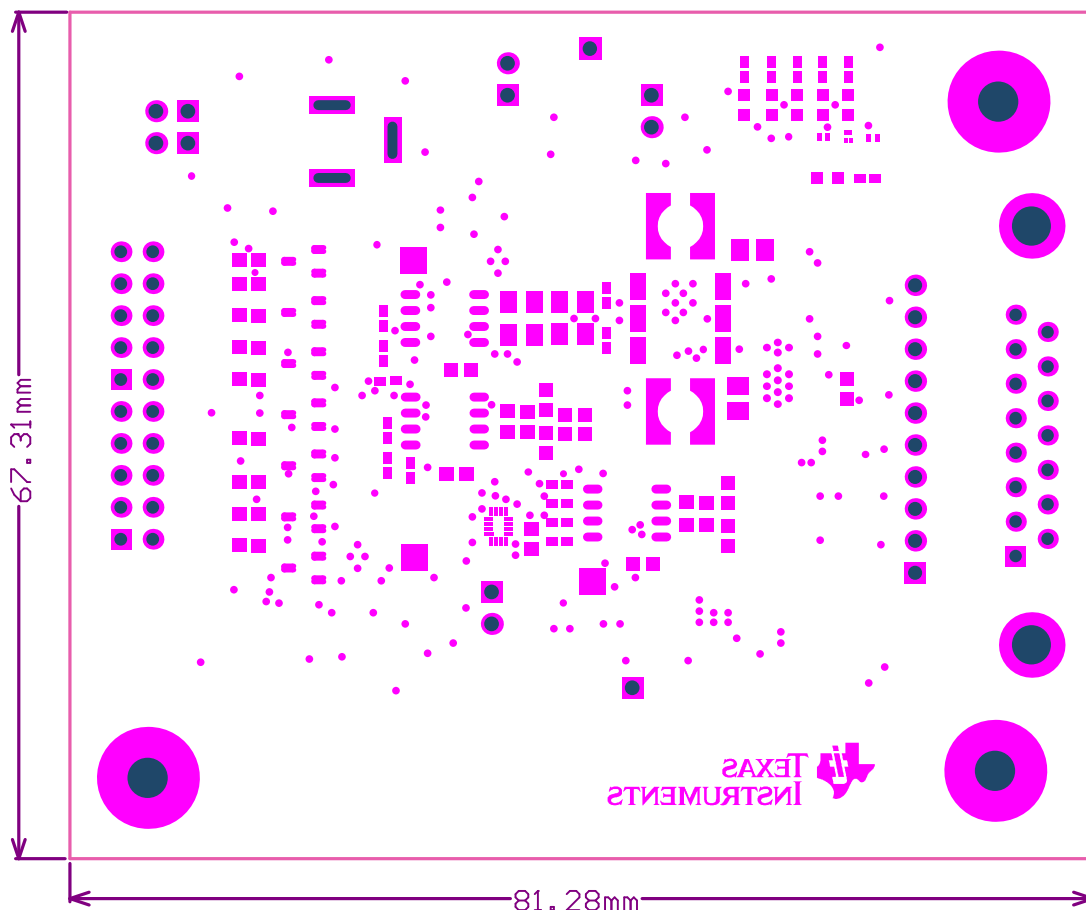
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Mid Layer 1 - GND	GENERATED : 9/25/2015 10:28:31 AM	TEXAS INSTRUMENTS	



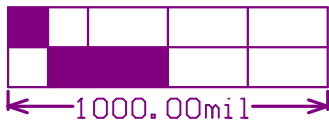
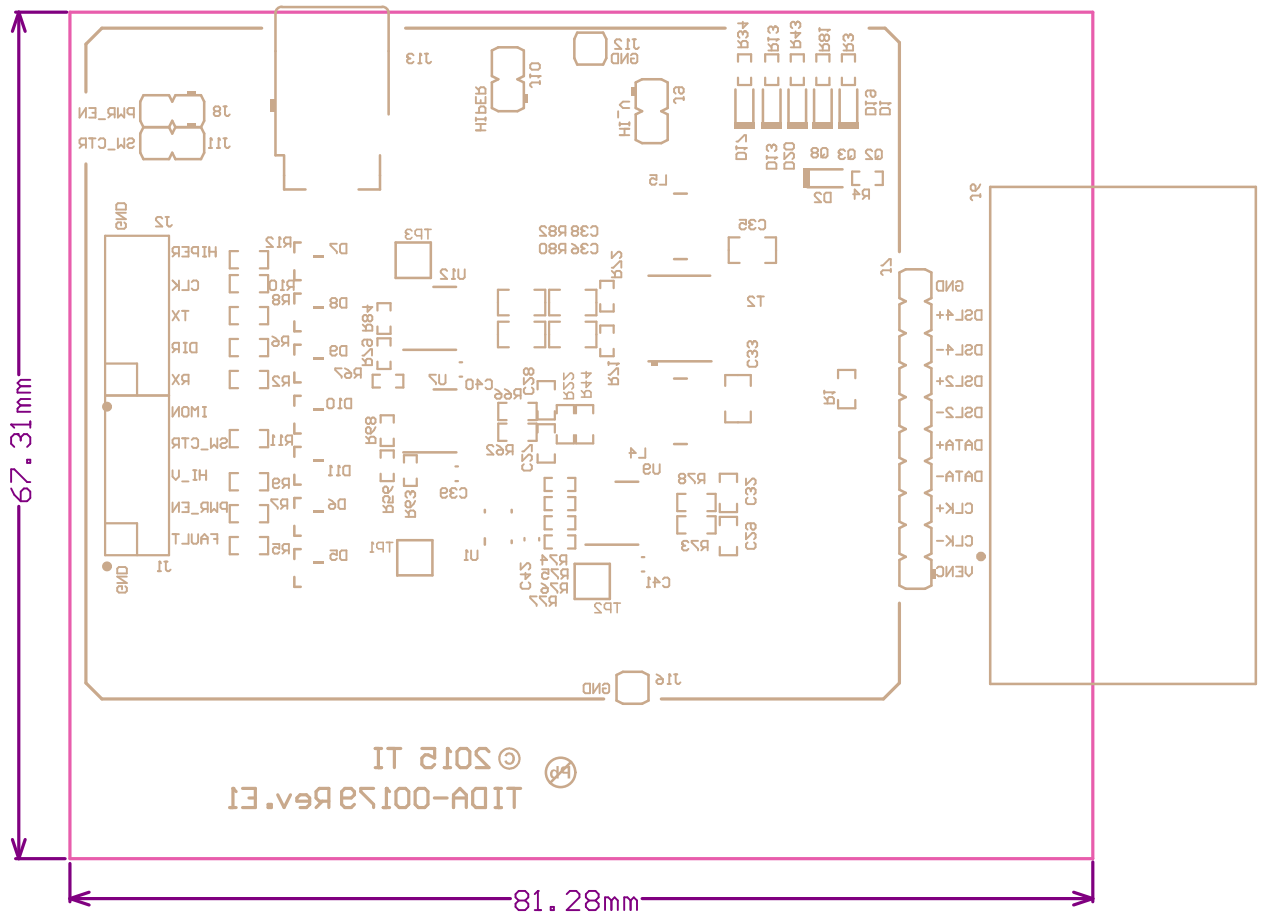
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Mid Layer 2 - VCC	GENERATED : 9/25/2015 10:28:32 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = <del>Bot Board</del> Dimensions			
PLOT NAME = Bottom Layer	GENERATED : 9/25/2015 10:28:33 AM	TEXAS INSTRUMENTS	

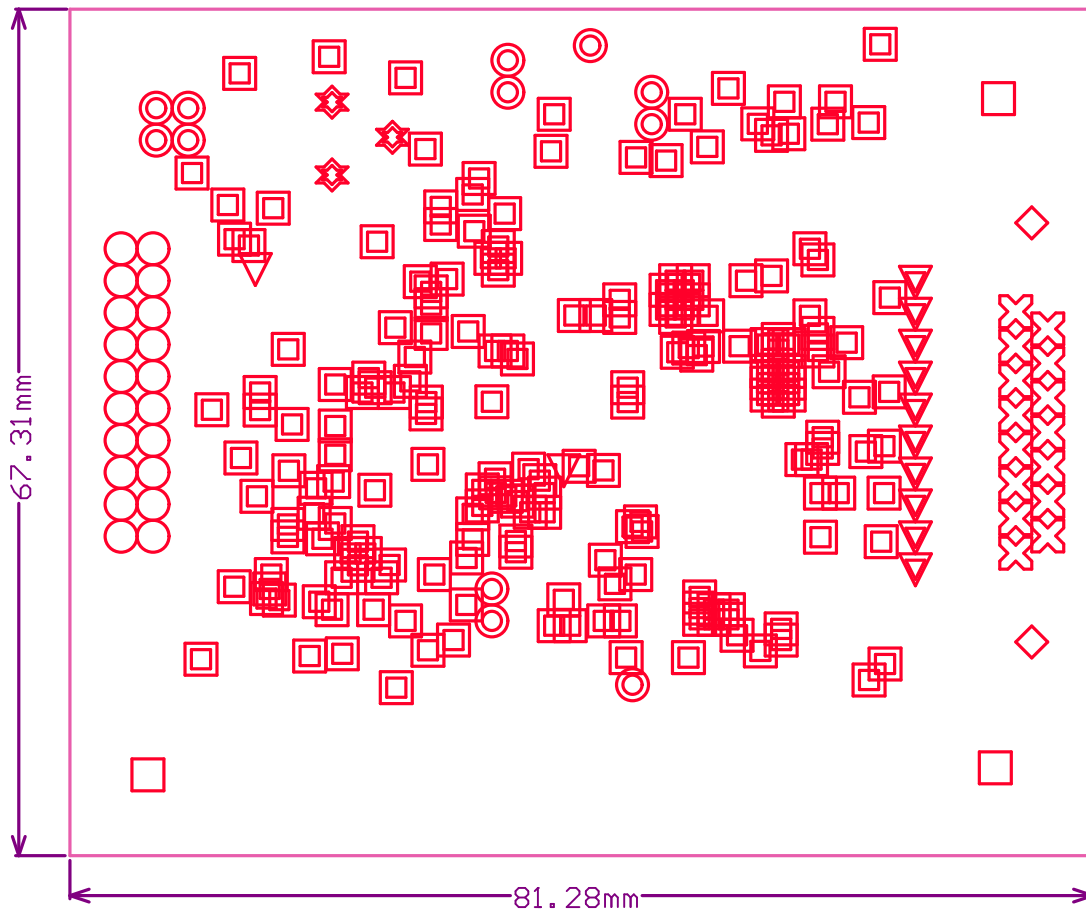


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = <del>M2</del> Board Dimensions			
PLOT NAME = Bottom Solder Mask	GENERATED : 9/25/2015 10:28:35 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = <del>M2 Board Dimensions</del>			
PLOT NAME = Bottom Overlay	GENERATED : 9/25/2015 10:28:36 AM	TEXAS INSTRUMENTS	





Symbol	Quantity	Finished Hole Size	Plate
▽	2	7.87mil (0.200mm)	PTH
■	200	8.00mil (0.203mm)	PTH
⊗	15	39.37mil (1.000mm)	PTH
○	20	40.00mil (1.016mm)	PTH
▽	10	43.31mil (1.100mm)	PTH
●	12	45.28mil (1.150mm)	PTH
◇	2	122.05mil (3.100mm)	PTH
□	3	125.98mil (3.200mm)	PTH
✱	3	31.50mil (0.800mm)	PTH
	267 Total		



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = <del>02 Board Dimensions</del>			
PLOT NAME = Drill Drawing	GENERATED : 9/25/2015 10:28:37 AM	TEXAS INSTRUMENTS	

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